

Features

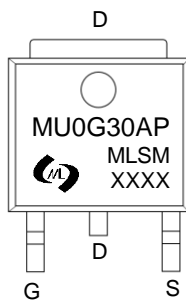
- High density cell design for ultra low R_{ds(on)}
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Product Summary

V _{DS}	R _{DS(ON)} TYP	I _D
-60V	32mΩ@-10V	-30A
	45mΩ@-4.5V	

Application

- PWM applications
- Power management
- Load switch

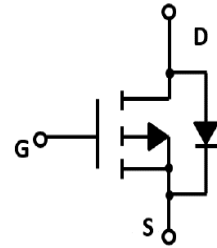


MU0G30AP: Device code
 XXXX : Code

Marking and pin assignment



TO-252 Top view



Schematic diagram



Pb-Free



RoHS



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
--------	-----------	--------	------

Common Ratings (TC=25°C Unless Otherwise Noted)

V _{DS}	Drain-Source Breakdown Voltage	-60	V
V _{GS}	Gate-Source Voltage	±20	V
T _J	Maximum Junction Temperature	150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
I _S	Diode Continuous Forward Current	Tc=25°C -30	A

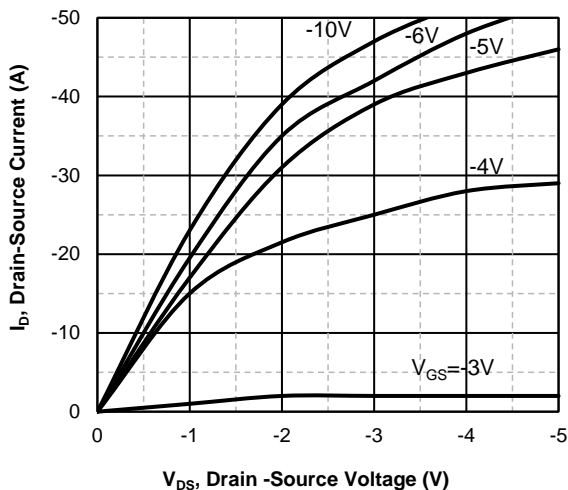
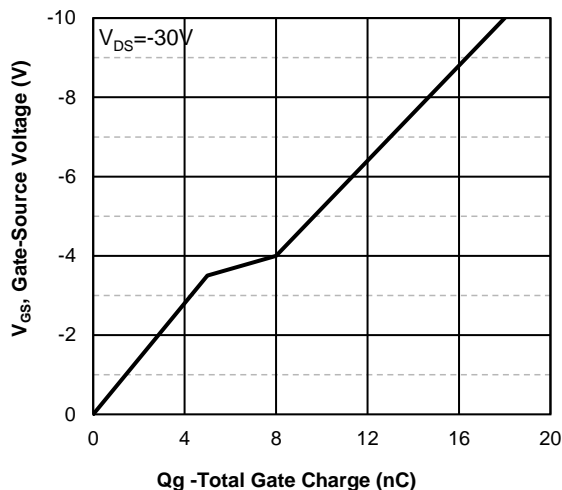
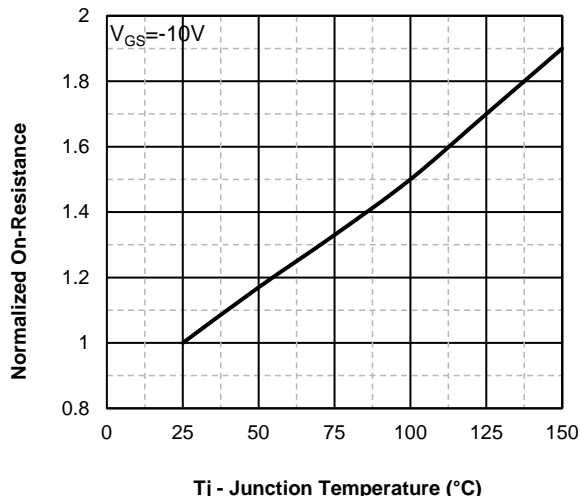
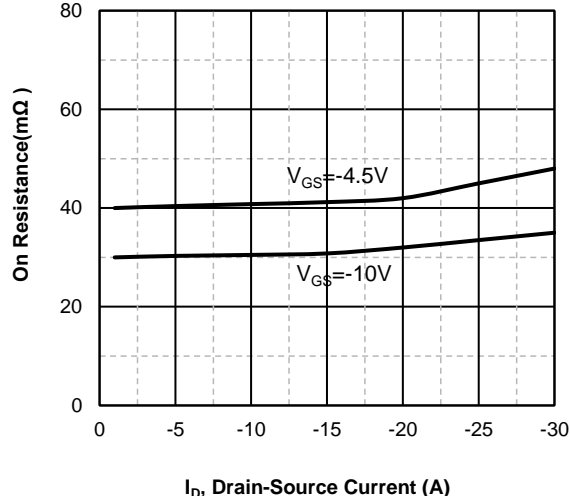
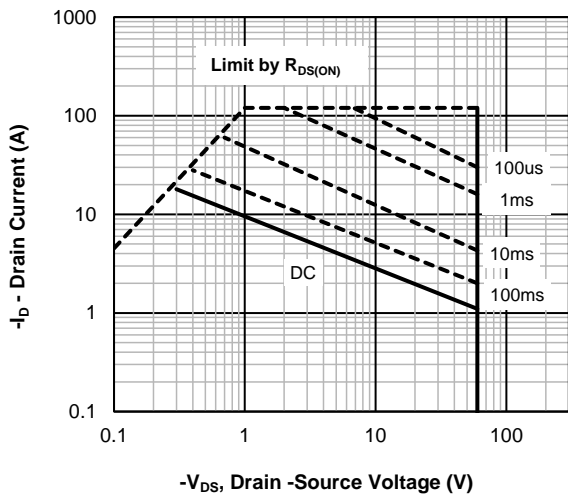
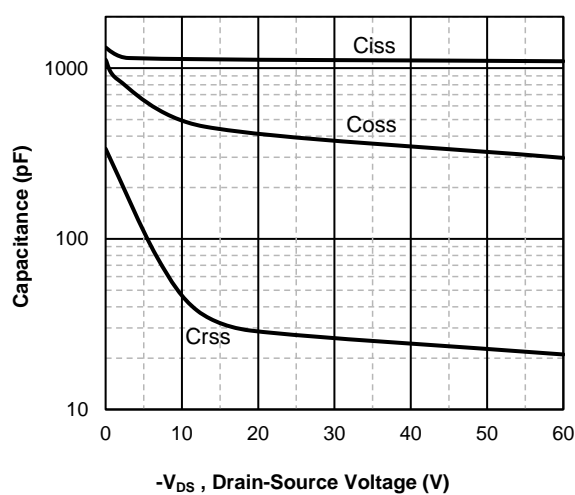
Mounted on Large Heat Sink

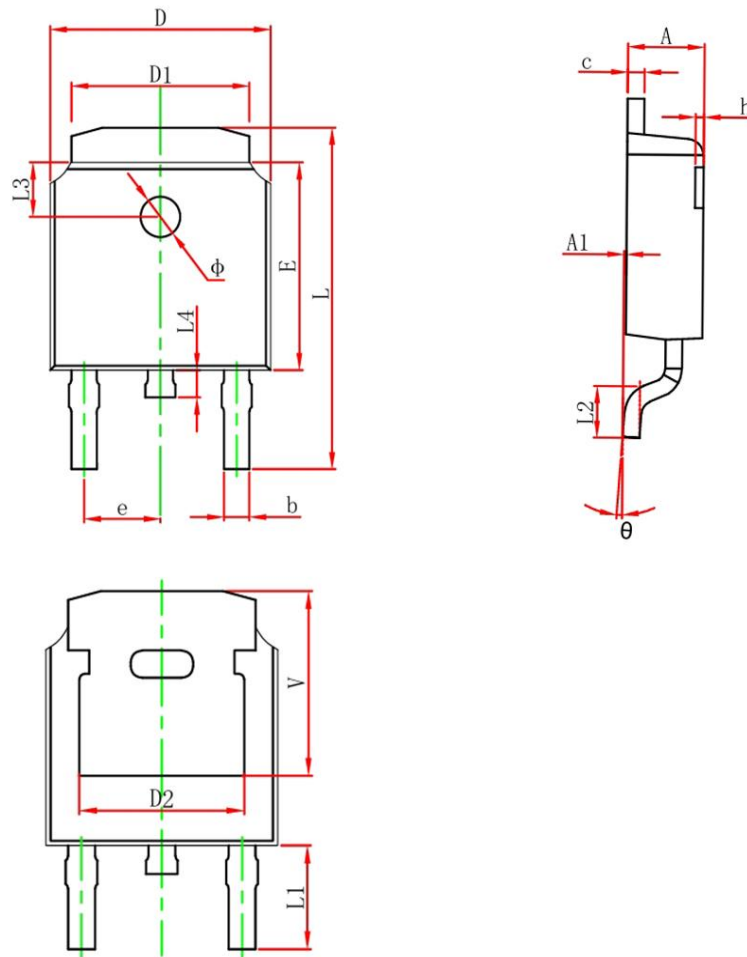
I _{DM}	Pulse Drain Current Tested	Tc=25°C -120	A
I _D	Continuous Drain Current	Tc=25°C -30	A
P _D	Maximum Power Dissipation	Tc=25°C 72	W
R _{θJA}	Thermal Resistance Junction-to-Ambient	40	°C/W

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MU0G30AP	TO-252	MU0G30AP	2,500	5,000	35,000	13"reel

Electrical Characteristics (T _J =25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-60	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-60V, V _{GS} =0V	--	--	-1.0	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1.0	-1.7	-2.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-20A	--	32	40	mΩ
		V _{GS} =-4.5V, I _D =-10A	--	45	60	mΩ
Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
C _{ISS}	Input Capacitance	V _{DS} =-30V, V _{GS} =0V, f=1MHz	--	1100	--	pF
C _{OSS}	Output Capacitance		--	350	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	28	--	pF
Switching Characteristics						
Q _g	Total Gate Charge	V _{DS} =-30V, I _D =-30A, V _{GS} =-10V	--	18.7	--	nC
Q _{gs}	Gate Source Charge		--	4.7	--	nC
Q _{gd}	Gate Drain Charge		--	3	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =-30V, I _D =-30A, V _{GS} =-10V, R _G =6Ω	--	7.5	--	nS
t _r	Turn-on Rise Time		--	39.5	--	nS
t _{d(off)}	Turn-Off Delay Time		--	43.6	--	nS
t _f	Turn-Off Fall Time		--	55.1	--	nS
Source- Drain Diode Characteristics						
V _{SD}	Forward on voltage	T _J =25°C, I _S =-30A	--	--	-1.2	V

Typical Operating Characteristics

Fig1. Typical Output Characteristics

Fig2. Typical Gate Charge Vs. Gate-Source Voltage

Fig3. Normalized On-Resistance Vs. Temperature

Fig4. Drain-Source on Resistance Vs. Drain-Source Current

Fig5. Maximum Safe Operating Area

Fig6. Typical Capacitance Vs. Drain-Source Voltage

TO-252 Package information


Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.635	0.770	0.025	0.030
c	0.450	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.712	10.312	0.386	0.406
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.250 REF.		0.207 REF.	